

# M2S060-FG676I

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### M2S060-FG676I Information

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	Manufacturer	Microsemi Corporation
	Category	Integrated Circuits (ICs) Embedded - System On Chip (SoC)
	Description	IC FPGA SOC 60K LUTS
	Package	676-BGA
		For the pricing/inventory/lead time, please contact us
For Reference Only		Website: https://www.heisener.com E-mail: salesdept@heisener.com



Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



# M2S060-FG676I Specifications

Manufacturer Part Number	M2S060-FG676I	
Manufacturer	Microsemi Corporation	
Category	Integrated Circuits (ICs)	
	Embedded - System On Chip (SoC)	
Package	676-BGA	
Series	SmartFusion?2	
Architecture	MCU, FPGA	
Core Processor	ARM? Cortex?-M3	
Flash Size	256KB	
RAM Size	64KB	
Peripherals	DDR, PCIe, SERDES	
Connectivity	CAN, Ethernet, I2C, SPI, UART/USART, USB	
Speed	166MHz	
Primary Attributes	FPGA - 60K Logic Modules	
Operating Temperature	-40°C ~ 100°C (TJ)	
Package / Case	676-BGA	
Supplier Device Package	676-FBGA (27x27)	
	Report errors?	

#### M2S060-FG676I Guarantees



Quality Guarantees

We provide 90 days warranty. \* If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



#### **Service Guarantees**

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

#### M2S060-FG676I Payment Methods



# M2S060-FG676I Shipping Methods



If you have any question about M2S060-FG676I, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com